RE01 1500KB, 256KB Group

CMSIS Driver R_PMIP Specifications

Summary

This document describes the specifications of the R_PMIP driver provided in the CMSIS software package for the RE01 1500KB and 256KB group (hereinafter referred to as the PMIP driver).

Target Device

Device: RE01 1500KB group, 256KB group

Parallel MIP LCD panel (monochrome): TN0104ANVAANN-GN00 (Kyocera)

When applying this driver to a microcontroller or a parallel MIP LCD panel other than the above, modification should be made as appropriate to match the specification of the device and careful evaluation performed.

Contents

1. Overview

The R-PMIP driver allows the RE01 1500KB, 256KB group products to output image data to a parallel MIP LCD panel.

The overview of this driver is shown in the table below.

Table 1-1 Overview of PMIP Driver

Overview of Driver Operation	Peripheral Modules Used	Driver Modules Mainly Used
Outputs image data to a parallel MIP LCD panel using the MIP LCD controller (MLCD). DMAC is used for data input to MLCD.	LPM, DMAC	R_LPM, R_DMAC

2. Driver Configuration

2.1 File Configuration

The R_PMIP driver conforms to the CMSIS HAL driver package and consists of three files: r_pmip_api.c, r_pmip_api.h, and r_pmip_cfg.h in the vendor-specific file storage directory. The functions of the files are shown in Table 2-1 and the file configuration is shown in Figure 2-1.

Table 2-1 Functions of Files of R_PMIP Driver

File Name	Description
r_pmip_api.c	Driver source file It provides the detail of the driver function. To use the R_PMIP driver, it is necessary to build this file.
r_pmip_api.h	Driver header file The macro, type, and prototype declarations that can be referenced by the user are defined. To use the R_PMIP driver, it is necessary to include this file.
r_pmip_cfg.h	Configuration definition file It provides configuration definitions that can be modified by the user.

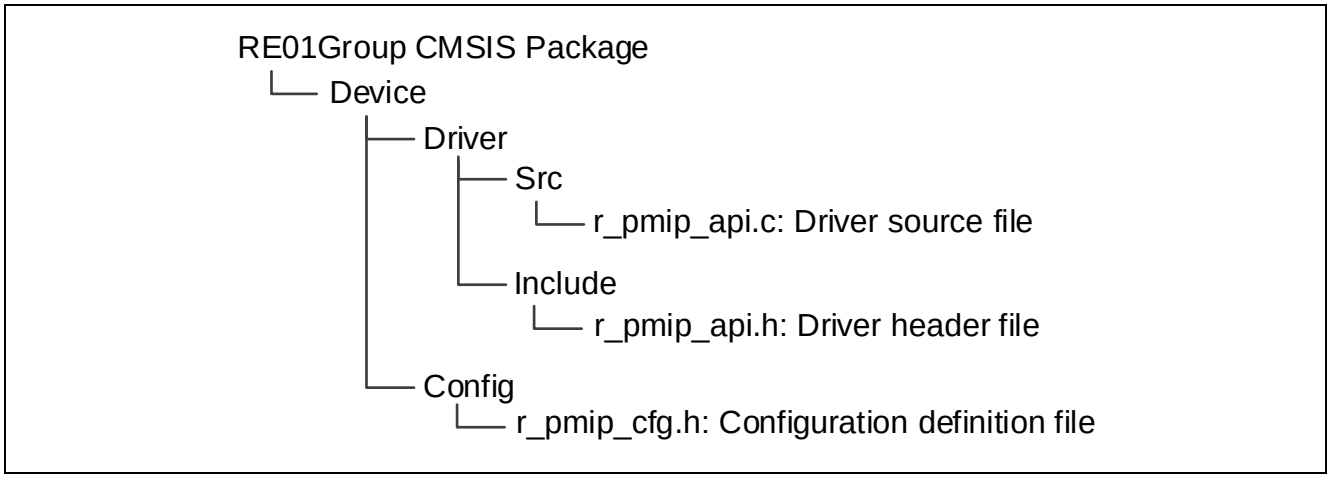


Figure 2-1 File Configuration of PMIP Driver

2.2 Configurations

For the R_PMIP driver, the configuration definitions that can be modified by the user are provided in the r_pmip_cfg.h or r_pmip_api.h file. Table 2-2 and Table 2-3 show lists of configurations.

Table 2-2 Settings of r_pmip_cfg.h

Name	Description	Setting Value	Initial Value
PMIP_ CFG_DISP_WIDTH	MIP LCD horizontal size (no. of pixels)	Set according to the specification of a parallel MIP LCD panel	176
PMIP_ CFG_DISP_HEIGHT	MIP LCD vertical size (no. of pixels)	Set according to the specification of a parallel MIP LCD panel	176
PMIP_CFG_SCLKH	High width of transmission clock (μs)	Set according to the specification of a parallel MIP LCD panel	1
PMIP_ CFG_VCOM_CLK	VCOM Output High-Width Setting	Selected from among MLCDVCOMCTL.VCOMW[1:0] bit setting values 0: 500ms (VCOMW[1:0]=01b) 1: 1000ms (VCOMW[1:0]=00b) 2: 2000ms (VCOMW[1:0]=10b) 3: 5000ms (VCOMW[1:0]=11b)	0
PMIP_CFG_PARAM_CK_ EN	Parameter check function	0: Disabled 1: Enabled	1
PMIP_CFG_ENB_TBL	Enable signal control table select	0: Kyocera (TN0104ANVAANN-GN00)(Note1) 1: Other	0
PMIP_CFG_INTERRUPT_ LEVEL	MLCD interrupt priority level	0 (high) to 3 (low)	0
PMIP_CFG_DISP_INI_DA TA	MIP-LCD initialization data selection when calling PowerOn API	Set according to the specifications of the parallel MIP LCD panel 0: Output 0x00 1: Output 0xFF Set "0" when your panel is Normally White and "1" when it is Normally Black	1
PMIP_CFG_FMASK_US (Note2)	VCOM mask time before data transfer	Set VCOM mask time before data transfer(Note4)	4000
PMIP_CFG_BMASK_US (Note3)	VCOM mask time after data transfer	Set VCOM mask time after data transfer(Note4)	1000
PMIP_CFG_SUPPORT_D MAC	Select whether to enable or disable DMAC	0: DMAC disabled 1: DMAC enabled	1
PMIP_CFG_SUPPORT_D TC	Select whether to enable or disable DTC	0: DTC disabled(Note5)	0

Note1. When PMIP_CFG_ENB_TBL = 0 is selected, the shortest enable signal width that can be used by the Kyocera TN0104ANVAANN-GN00 is automatically set. When setting the enable signal width to an arbitrary value, or when using another parallel MIP LCD panel, PMIP_CFG_ENB_TBL should be set to 1.

Note2. Available only for 256KB groups.
The setting value is converted to the value set in the MLCDVCOMCTL.FMASK [7: 0] bits.

Note3. Available only for 256KB groups.
The setting value is converted to the value set in the MLCDVCOMCTL.BMASK [7: 0] bits.

Note4. In the actual mask time, an error of 0 to 488us (sampling cycle) occurs from the set value.
[Setting Example]
Setting value: 4000us
Mask time: 4392us (488 * 9)

Note5. DTC transfer is not supported. Be sure to set the value to 0.

Table 2-3 Settings of r_pmip_api.h

Name	Description	Setting Value	Initial Value
OTHER_ENB (e_pmip_enb_tbl_other_t)	t_{oENB}[us] and t_{bENB}[us](Note)	Set according to the specification of parallel MIP LCD used * Set a larger value than that of PMIP_CFG_SCLKH.	4
OTHER_ENBH (e_pmip_enb_tbl_other_t)	t_{wENBH}[us](Note)	Set according to the specification of parallel MIP LCD used	20

Note: Valid only when the "Other" table is selected (PMIP_CFG_ENB_TBL = 1). For details including t_{oENB}, refer to section 58.3.12, MCLD Timing, in the User's Manual: Hardware.

2.3 Macro and Type Definitions

For the R_PMIP driver, the configuration definitions that can be modified by the user are provided in the r_pmip_api.h file.

2.3.1 Type Definitions

Definition	Value	Description
e_trans_mode_t	DMAC_TR	DMAC transfer
	CPU_TR	CPU transfer
e_trans_cmd_t	CMD0	Bit array for data transmission
	CMD1	Horizontal address auto update method
	CMD2	Vertical address auto update method

2.3.2 PMIP Error Code Definitions

These define the PMIP error codes.

Table 2-4 List of PMIP Error Code Definitions

Definition	Description	Solution
PMIP_OK	Normal completion	-
PMIP_ERROR	MLCD module clock start error	LPM driver error occurs. See the R_LPM_ModuleStart function of LPM driver.
	MLCD module clock stop error	LPM driver error occurs. See the R_LPM_ModuleStop function of LPM driver.
	MLCD system initial processing error	1. Execute the R_PMIP_Open function before transmission. 2. LPM driver error occurs. Refer to the LPM driver specification document.
PMIP_ERROR_TRANS_MODE	Transfer method setting error	Set either DMAC_TR or CPU_TR for the argument tr_mode.mode of R_PMIP_Open.
PMIP_ERROR_DMAC_TRANS	Error occurrence on selected DMAC channel	DMAC driver error occurs. Refer to the DMAC driver specification document.
PMIP_ERROR_DMAC_CFG	DMAC channel setting error	Set one of 0 to 3 values for the argument tr_mode.sel of R_PMIP_Open.
	Selected DMAC channel in use	The selected DMAC channel is in use. Set an unused DMAC channel for the argument tr_mode.sel of R_PMIP_Open.
PMIP_ERROR_INPUT _CLK_OFFRANGE	Transmit clock high width setting error	Set so as to meet the condition: PMIP_CFG_SCLKH(us)* System clock (Hz) / 1000000 <256
PMIP_ERROR_ENBEG_CFG	ENBG signal width setting error	1. Set so as to meet the condition: KYOCERA_ENB > PMIP_CFG_SCLKH or OTHER_ENB > PMIP_CFG_SCLKH 2. The calculated ENBG width overflows.
PMIP_ERROR_CONTROL _CMD	Command setting error	Set one of CMD0, CMD1 and CMD2 for the argument cmd of R_PMIP_Control.
	Command setting value error	Set either 0 or 1 for the argument set of R_PMIP_Control
PMIP_ERROR_SEND_CFG	Transmission parameter setting error	Set so as to meet the conditions: st_h: 0 to (PMIP_ CFG_DISP_WIDTH-1); however, a multiple of 8 st_v: 0 to (PMIP_ CFG_DISP_HEIGHT-1) size_h: 1 to (PMIP_ CFG_DISP_WIDTH/8) size_v: 1 to PMIP_ CFG_DISP_HEIGHT img_size_h: 2 to (PMIP_ CFG_DISP_WIDTH/8)
PMIP_ERROR_SYSTEM _SETTING	Interrupt setting error	Set an interrupt priority level or an MLCD interrupt. Interrupt setting means setting of r_system_cfg.h file in the Config folder.
PMIP_ERROR_BUSY	busy error	A busy error has occurred during PMIP transfer. The process that generates this error can only be executed while the PMIP transfer is stopped. Please execute it again after the PMIP transfer is completed.
PMIP_ERROR_RECONFIG	reconfiguration error	An error has occurred indicating that the reconfiguration process is in progress. PMIP transfer cannot be started during the reconfiguration process. Please execute again after the reconfiguration process is completed.

2.3.3 PMIP Event Definitions

These define the PMIP events.

Definition	Value	Description
PMIP_EVENT_SEND_COMPLETE	1	Data output completed
PMIP_EVENT_ERROR_DMAC_TRANS	2	Data output failed

2.4 Structure Definitions

For the PMIP driver, the structures that can be modified by the user are defined in the r_pmip_api.h file.

2.4.1 st_transmode_t Structure

Element Name	Type	Description
mode	e_trans_mode_t	Transfer mode * DTC transfer is not supported.
sel	uint8_t	DMAC channels 0: DMAC0 1: DMAC1 2: DMAC2 3: DMAC3 * Invalid if CPU transfer is selected (mode=CPU_TR)

2.4.2 st_mlcd_mode_info_t Structure

Element Name	Type	Description
cb_event	pmip_cb_event_t	Callback function
flags	uint8_t	Flag used for DMA transfer * Should not be changed

3. State Transitions

The state transition diagram of the PMIP driver is shown in Figure 3-1.

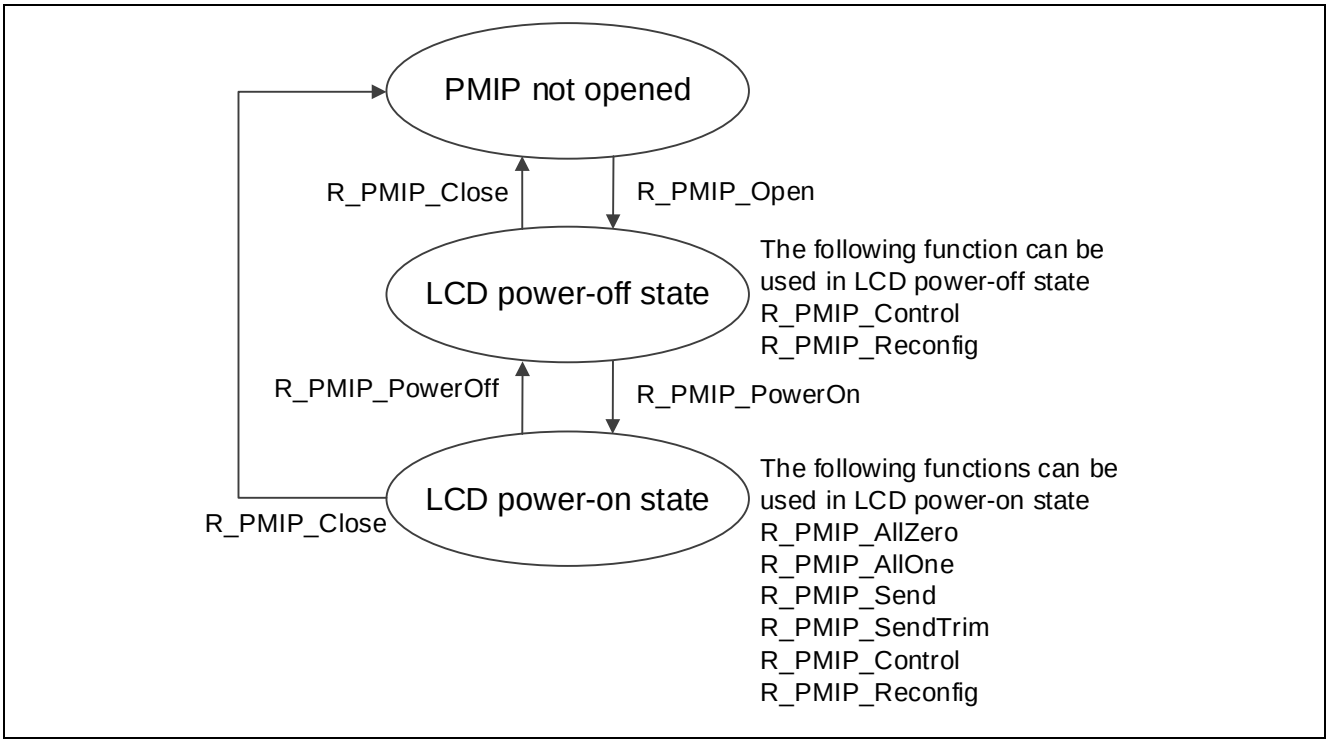


Figure 3-1 State Transitions (Note 1)

Note The R_PMIP_GetVersion function can be called from any state.

4. Driver Functions

4.1 Function Specifications

4.1.1 R_PMIP_Open

Overview	System initial processing	
Format	e_pmip_err_t R_PMIP_Open(pmip_cb_event_t cb, st_transmode_t* tr_mode)	
Description	The MLCD module stop bit is cancelled, a burn-in prevention signal (VCOM), memory rewrite activating signal (ENB), transmission clock high width (µs), transfer, and callback function are set. In setting the transmission clock high width, the current system clock frequency is acquired within this function, and calculations and settings are made such that the clock frequency high width matches PMIP_CFG_SCLKH.	
Argument	pmip_cb_event_t cb	Callback function
	tr_mode.mode	Transmission method selection
	tr_mode.sel	DMAC channel selection
Return Value	PMIP_OK PMIP_ERROR PMIP_ERROR_TRANS_MODE PMIP_ERROR_DMAC_CFG PMIP_ERROR_INPUT_CLK_OFFRANGE PMIP_ERROR_ENBEG_CFG PMIP_ERROR_SYSTEM_SETTING	
Remarks	・**Operate the clock correction circuit (CCC)** before calling the R_PMIP_Open function (see chapter 5 for how to operate it). ・t_{oENB} and t_{bENB} are calculated by the following equation. t_{oENB} , t_{bENB} = (SCLK high width) + (ENBEG[7:0]*PCLKA 1 cycle)	

4.1.2 R_PMIP_PowerOn

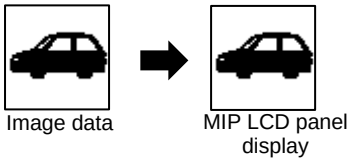
Overview	MIP power-on sequence
Format	e_pmip_err_t R_PMIP_PowerOn(void)
Description	Performs power-on sequence of the parallel MIP-LCD. When PMIP_CFG_DISP_INI_DATA is 1, all bits of the parallel MIP-LCD are initialized to “1”. When PMIP_CFG_DISP_INI_DATA is 0, all bits of the parallel MIP-LCD are initialized to “0”.
Argument	None
Return Value	PMIP_OK PMIP_ERROR
Remarks	

4.1.3 R_PMIP_Control

Overview	Transmission setting	
Format	e_pmip_err_t R_PMIP_Control(e_trans_cmd_t cmd, void* set)	
Description	Set any one among the following settings • Bit array for data transmission (MLCDCR.BITSW) • Horizontal address auto-update method (MLCDCR.HADDRDEC) • Vertical address auto-update method (MLCDCR.VADDRDEC) By modifying these settings, horizontal and vertical inverted display of image data is possible.	
Argument	e_trans_cmd_t cmd void* set	Selects a setting item and value. ◆ When cmd = CMD0 (uint8_t)set 0: MSB transfer 1: LSB transfer ◆ When cmd = CMD1 (uint8_t)set 0: Address incremented 1: Address decremented ◆ When cmd = CMD2 (uint8_t)set 0: Address incremented 1: Address decremented
Return Value	PMIP_OK PMIP_ERROR PMIP_ERROR_CONTROL_CMD	
Remarks	Examples of calling function	

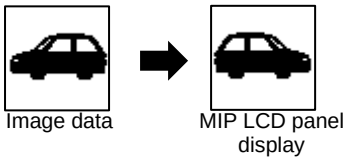
◆ Normal display

```
R_PMIP_Control(CMD0,0); /* default */
R_PMIP_Control(CMD1,0); /* default */
R_PMIP_Control(CMD2,0); /* default */
R_PMIP_Send(0,0,32,256,img);
```



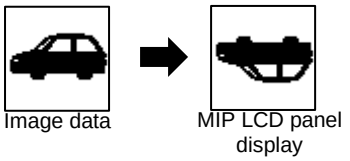
◆ Horizontally inverted display

```
R_PMIP_Control(CMD0,1);
R_PMIP_Control(CMD1,1);
R_PMIP_Send(248,0,32,256,img);
```



◆ Vertically inverted display

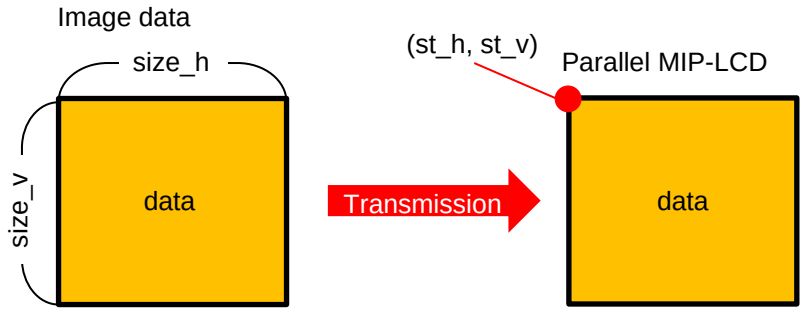
```
R_PMIP_Control(CMD2,1);
R_PMIP_Send(0,255,32,256,img);
```



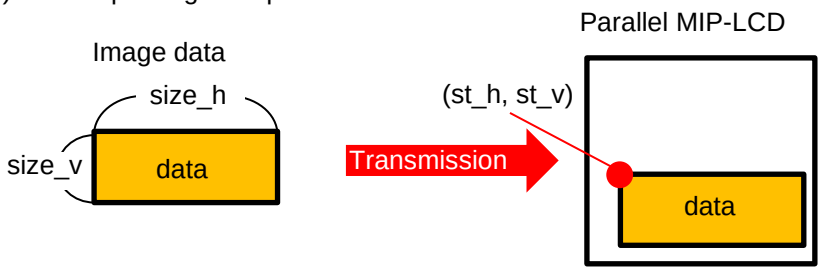
4.1.4 R_PMIP_Send

Overview	Data transmission
Format	e_pmip_err_t R_PMIP_Send(uint8_t st_h, uint8_t st_v, uint8_t size_h, uint16_t size_v, uint8_t* &data)
Description	Outputs the image data (size_h bits × size_v bits) to the coordinates of the parallel MIP-LCD (st_h, st_v).

1) When updating LCD full-screen data



2) When updating LCD partial screen data

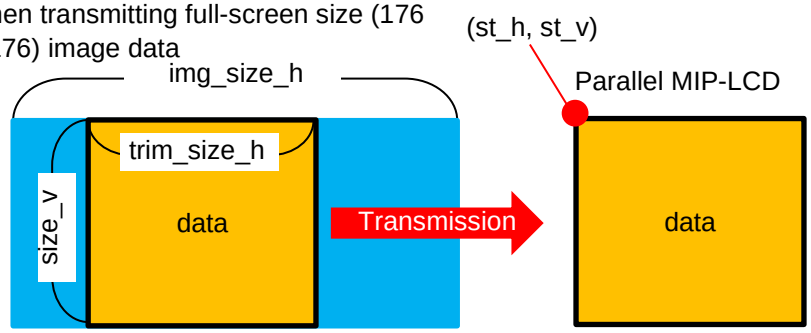


Argument	uint8_t st_h	Transmit start pixel (horizontal) (SL)
	uint8_t st_v	Transmit start pixel (vertical) (GL)
	uint8_t size_h	Transmit data size (no. of horizontal bytes)
	uint16_t size_v	Transmit data size (no. of vertical rows)
	uint8_t* &data	Memory address of transmit data
Return Value	PMIP_OK	
	PMIP_ERROR	
	PMIP_ERROR_DMAC_TRANS	
	PMIP_ERROR_SEND_CFG	
	PMIP_ERROR_SYSTEM_SETTING	
Remarks	A multiple of 8 should be set for transmit start pixel (SL).	

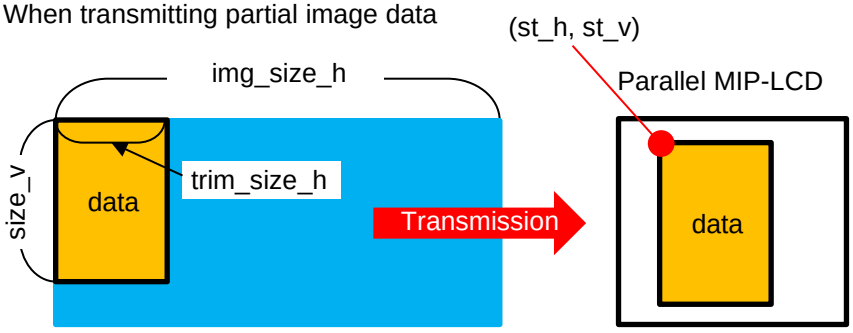
4.1.5 R_PMIP_SendTrim

Overview	Data transmission
Format	e_pmip_err_t R_PMIP_SendTrim(uint8_t st_h, uint8_t st_v, uint16_t img_size_h, uint8_t trim_size_h, uint16_t size_v, uint8_t* &data)
Description	Outputs image data (trim_size_h bits ×size_v bits) to coordinates (st_h, st_v) of a parallel MIP-LCD. The horizontal size of the image data is img_size_h, and a part with a clipping size trim_size_h is clipped and output.

1) When transmitting full-screen size (176 × 176) image data



2) When transmitting partial image data



Argument	uint8_t st_h	Transmit start pixel (horizontal) (SL)
	uint8_t st_v	Transmit start pixel (vertical) (GL)
	uint16_t img_size_h	Transmit data size (no. of horizontal bytes)
	uint8_t trim_size_h	Transmit data clipping size (no. of horizontal bytes)
	uint16_t size_v	Transmit data size (no. of vertical rows)
	uint8_t* &data	Memory address of transmit data
Return Value	PMIP_OK	
	PMIP_ERROR	
	PMIP_ERROR_DMAC_TRANS	
	PMIP_ERROR_SEND_CFG	
	PMIP_ERROR_SYSTEM_SETTING	
Remarks	A multiple of 8 should be set for transmit start pixel (SL).	

4.1.6 R_PMIP_AllOne

Overview	Transmission of data 1s for the entire screen
Format	e_pmip_err_t R_PMIP_AllOne(void)
Description	Outputs 1s for all bits of the parallel MIP-LCD
Argument	None
Return Value	PMIP_OK
	PMIP_ERROR
Remarks	

4.1.7 R_PMIP_AllZero

Overview	Transmission of data 0s for the entire screen
Format	e_pmip_err_t R_PMIP_AllZero(void)
Description	Outputs 0s for all bits of the parallel MIP-LCD
Argument	None
Return Value	PMIP_OK PMIP_ERROR
Remarks	

4.1.8 R_PMIP_PowerOff

Overview	MIP power-off sequence
Format	e_pmip_err_t R_PMIP_PowerOff(void)
Description	Performs power-off sequence of the parallel MIP-LCD.
Argument	None
Return Value	PMIP_OK PMIP_ERROR
Remarks	

4.1.9 R_PMIP_Close

Overview	System termination processing
Format	e_pmip_err_t R_PMIP_Close(void)
Description	Initializes the value specified in R_SMIP_Open and sets the MLCD module stop bit to a stop state for system termination processing.
Argument	None
Return Value	PMIP_OK PMIP_ERROR
Remarks	CCC should not be stopped. If CCC needs to be stopped, set with the user program.

4.1.10 R_PMIP_GetVersion

Overview	API version acquisition
Format	uint32_t R_PMIP_GetVersion(void)
Description	Acquires the API version
Argument	None
Return Value	PMIP driver version
Remarks	

4.1.11 R_PMIP_Reconfig

Overview	PMIP clock reconfiguration process
Format	e_pmip_err_t R_PMIP_Reconfig(void)
Description	Obtain the current system clock frequency and reconfigure the memory rewrite active signal (ENB) and the transmit clock High width (us). Calculate and set the High width of the clock frequency to match PMIP_CFG_SCLKH.
Argument	None
Return Value	PMIP_OK PMIP_ERROR PMIP_ERROR_RECONFIG PMIP_ERROR_BUSY PMIP_ERROR_INPUT_CLK_OFFRANGE PMIP_ERROR_ENBEG_CFG
Remarks	This function cannot be used during MLCD data transmission operation (PMIP_ERROR_BUSY is returned).

4.2 Setting Interrupts

The interrupts that are used for communication control must be registered to NVIC using the r_system_cfg.h file. For details on interrupts (NVIC), refer to the "Interrupt Control" in the RE01 1500KB, 256KB Group Getting Started Guide to Development Using CMSIS Package (r01an4660). The interrupt definitions to beused by the PMIP driver are shown in Table 4-1, and an example of interrupt registration is shown in Figure 4-1.

Table 4-1 NVIC Registration Definitions

NVIC Registration Definition
SYSTEM_CFG_EVENT_NUMBER_MLCD_TEI
SYSTEM_CFG_EVENT_NUMBER_MLCD_TEMI

```
#define SYSTEM_CFG_EVENT_NUMBER_SCI5_TXI
                (SYSTEM_IRQ_EVENT_NUMBER_NOT_USED)    /*!< Numbers 1/9/17/25 only */
#define SYSTEM_CFG_EVENT_NUMBER_MLCD_TEI
                (SYSTEM_IRQ_EVENT_NUMBER9)    /*!< Numbers 1/9/17/25 only */
#define SYSTEM_CFG_EVENT_NUMBER_PORT_IRQ5
                (SYSTEM_IRQ_EVENT_NUMBER_NOT_USED)    /*!< Numbers 5/13/21/29 only */
...
#define SYSTEM_CFG_EVENT_NUMBER_SPI1_SPII
                (SYSTEM_IRQ_EVENT_NUMBER_NOT_USED)    /*!< Numbers 2/10/18/26 only */
#define SYSTEM_CFG_EVENT_NUMBER_MLCD_TEMI
                (SYSTEM_IRQ_EVENT_NUMBER10)    /*!< Numbers 2/10/18/26 only */
#define SYSTEM_CFG_EVENT_NUMBER_PORT_IRQ9
                (SYSTEM_IRQ_EVENT_NUMBER_NOT_USED)    /*!< Numbers 2/10/18/26 only */
...
```

Figure 4-1 Example of Interrupt Registration to NVIC in r_system_cfg.h

5. Driver Use Examples

Figure 5-1 shows a setting example when outputting an image using the PMIP driver.

```
#include "r_pmip_api.h"
#include "r_system_api.h"
#include "r_lpm_api.h"

static void callback(uint32_t event);
void set_ccc(void);
extern const uint8_t image[3872]; /* 176 x 176 bit monochrome image data */
main()
{
    st_transmode_t tmd;
    tmd.mode = DMAC_TR;
    tmd.sel   = 0; // DMAC channel select

    set_ccc();
```

```
    (void)R_PMIP_Open((pmip_cb_event_t)&callback, &tmd); // Initialization of system
    (void)R_PMIP_PowerOn(); // MIP power ON sequence
    (void)R_PMIP_Control(CMD0, (void*)1);

    While(1)
    {
        R_SYS_SoftwareDelay(1000, SYSTEM_DELAY_UNITS_MILLISECONDS);
        (void)R_PMIP_Send(0,0,22,176,image);
        R_SYS_SoftwareDelay(1000, SYSTEM_DELAY_UNITS_MILLISECONDS);
        (void)R_PMIP_AllZero();
    }
}

static void callback(uint32_t event)
{
    /* Describe the process when all transfers are completed */
    switch(event)
    {
        case PMIP_EVENT_SEND_COMPLETE:
        {
            /* Describe the process when transmission is normally completed */
        }
        break;
        case PMIP_EVENT_ERROR_DMAC_TRANS:
        {
            /* Describe the process when transmission error occurs */
        }
        break;
    }
}

void set_ccc(void)
{
  /* CCC needs to be set for VCOM operation of PMIP(MLCD) driver */
  R_LPM_ModuleStart(LPM_MSTP_CCC); // release of CCC module stop
  R_SYS_RegisterProtectEnable(SYSTEM_REG_PROTECT_CGC);
  R_SYS_SubOscSpeedClockStart();
  R_SYS_SoftwareDelay(1000, SYSTEM_DELAY_UNITS_MILLISECONDS); // wait 1s
  CCC->R128CTRL_b.CADJUSCEN = 1; /* Start CCC */
}
```

Figure 5-1 Example of PMIP Driver Setting and Transmission

6. Usage Notes

6.1 SCLK High Width Setting

The setting of the MLCDCR.SCKCR bit is calculated from PMIP_CFG_SCLKH and PCLKA. When the MLCDCR.SCKCR bit is 1, the width of the high signal actually output from the MLCD_SCLK pin has a NOP

time added, to become two cycles (PCLKA equivalent). Care must be exercised since this does not match the high width set by PMIP_CFG_SCLKH. For details, refer to section 58.3.12, MLCD Timing, in the User's Manual: Hardware.

6.2 Restrictions on Function Execution

The list of function execution restrictions in this driver is shown in Table 6-1.

Table 6-1 Restrictions on Function Execution

Function	Restriction
R_PMIP_Open	Can be used only in the PMIP unopened state
R_PMIP_PowerOn	Can be used only with PMIP open and "Reconfg" not running
R_PMIP_Control	
R_PMIP_Send	Can be used only when PMIP is open, LCD is powered on, and "Reconfg" is not executed.
R_PMIP_SendTrim	
R_PMIP_AllOne	
R_PMIP_AllZero	
R_PMIP_PowerOff	
R_PMIP_Close	Can be used only in the PMIP unopened state
R_PMIP_GetVersion	-
R_PMIP_Reconfig	Can be used only when PMIP is open and image data output is stopped.

7. Troubleshooting

7.1 No Output from MLCD_VCOM

A) Check to make sure the CCC clock has been set up correctly.

The CCC clock output should be set before executing the R_PMIP_Open function.

For details, see chapter 5, Driver Use Examples.

7.2 Occurrence of Hard Fault Error when API of CMSIS Driver Is Called

A) The API has not possibly been copied to RAM.

Before calling an API function that is mapped to RAM, make sure that it has been copied to RAM by the R_SYS_CodeCopy function. For details, refer to the related document No. R01AN4660.

7.3 Peripheral Function Fails to Operate when API Is Called

A) Check the API's return value to see if an error has occurred. In particular, errors are often caused by problems related to interrupts not being set in r_system_cfg.h. For details, refer to the related document No. R01AN4660.

7.4 Normal API Return Value But Peripheral Function Pin Fails to Work

A) Check to make sure the pins have been set up correctly by the functions in pin.c.

For details, refer to the related document No. R01AN4660.

8. Reference Documents

User's Manual: Hardware

RE01 1500KB Group User's Manual: Hardware R01UH0796
RE01 256KB Group User's Manual: Hardware R01UH0894
(The latest version can be downloaded from the Renesas Electronics website.)

RE01 Group CMSIS Package Getting Started Guide

RE01 1500KB, 256KB Group Getting Started Guide to Development Using CMSIS Package R01AN4660
(The latest version can be downloaded from the Renesas Electronics website.)

RE01 1500KB, 256KB Group CMSIS Driver R_LPM Specifications (R01AN4838)
(The latest version can be downloaded from the Renesas Electronics website.)

RE01 1500KB, 256KB Group CMSIS Driver R_DMAC Specifications (R01AN4730)
(The latest version can be downloaded from the Renesas Electronics website.)

Technical Update/Technical News
(The latest version can be downloaded from the Renesas Electronics website.)

User's Manual: Development Tools
(The latest version can be downloaded from the Renesas Electronics website.)

Revision History

Rev.	Date	Description	
		Summary	Summary
1.01	Dec.2.2019	—	First edition issued
		Program	Fixed the RAM / ROM placement in r_pmip_cfg.h. Fixed the problem that the following internal functions are not placed in RAM even if they are set in RAM. - e_mlcd_cpu_normal_trans function
1.03	Feb.25.2020	4	Added the following configuration definitions • PMIP_CFG_DISP_INI_DATA
		8	Added description of R_PMIP_PowerOn function
		Program	• Addition of definition (PMIP_CFG_DISP_INI_DATA) for selecting MIP-LCD initialization data when calling PowerOn API • Fixed incorrect RAM / ROM allocation of R_PMIP_Send function. • Fixed inadequate RAM / ROM allocation of internal variables (resources) - Changed the VCOM wait time in the R_PMIP_PowerOff function to 2ms
1.04	Mar.5.2020	—	Compatible with 256KB group
		4	Added the following configuration definitions • PMIP_CFG_FMASK_US • PMIP_CFG_BMASK_US
		Program (256KB)	• Modified to match 256KB IO definition • VCOM mask control changed from software control to hardware control • Added configuration definition for VCOM mask time setting - PMIP_CFG_FMASK_US - PMIP_CFG_BMASK_US
1.05	Apr.23.2020	4	Added the following configuration definitions • PMIP_CFG_SUPPORT_DMAC • PMIP_CFG_SUPPORT_DTC
		Program	Modified the description of PMIP_CFG_VCOM_CLK according to UMH Changed the configuration so that it can be built without DMAC and DTC drivers. Replace asm("nop"); with __NOP();
1.06	Nov.05.2020	—	Error correction
1.07	Feb.22.2021	13	Added R_PMIP_Reconfig Added "Table 6-1 Restrictions on Function Execution"
		Program	Added R_PMIP_Reconfig

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
2. Processing at power-on

   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
3. Input of signal during power-off state

   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
4. Handling of unused pins

   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
5. Clock signals

   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
6. Voltage application waveform at input pin

   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).
7. Prohibition of access to reserved addresses

   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
8. Differences between products

   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

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